MSX1PB, MSX1PD, MSX1PG, MSX1PJ

Vishay General Semiconductor

Surface-Mount ESD Capability Rectifier

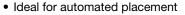
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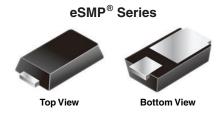


COMPLIANT HALOGEN

FREE



- Oxide planar chip junction
- · Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



MicroSMP (DO-219AD)

PRIMARY CHARACTERISTICS					
I _{F(AV)} 1.0 A					
V_{RRM}	100 V, 200 V, 400 V, 600 V				
I _{FSM}	18 A				
V _F at I _F = 1.0 A (125 °C)	0.9 V				
T _J max.	175 °C				
Package	MicroSMP (DO-219AD)				
Diode variations	Single				

TYPICAL APPLICATIONS

General purpose, polarity protection, and rail-to-rail protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free and RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 gualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	MSX1PB	MSX1PD	MSX1PG	MSX1PJ	UNIT	
Device marking code		XB	XD	XG	XJ		
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V	
Maximum average forward rectified current	I _{F(AV)}	1.0			Α		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	18				Α	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175				°C	

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
	$I_F = 0.5 A$	T _A = 25 °C T _A = 125 °C	V _F ⁽¹⁾	0.93	-	V	
Maximum instantaneous forward voltage	I _F = 1.0 A			1.0	1.1		
	I _F = 0.5 A			0.81	-		
	I _F = 1.0 A			0.9	0.98		
Maximum reverse current	Rated V_R $T_A = 25 °C$ $T_A = 125 °C$	I _R ⁽²⁾	-	1.0			
Maximum reverse current		T _A = 125 °C	IR (=)	4.1	50	μA	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	960	-	ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	5	-	pF	

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms



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THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL MSX1PB MSX1PD MSX1PG MSX1PJ				UNIT		
Typical thermal resistance	R _{0JA} (1)		°C/W				
Typical thermal resistance	R _{0JL} (1)	30				G/ VV	

Note

⁽¹⁾ Thermal resistance from junction to ambient and junction to lead mounted on PCB with 5.0 mm x 5.0 mm copper pad areas. R_{θJL} is measured at the terminal of cathode band

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$, unless otherwise noted)							
STANDARD	D TEST TYPE TEST CONDITIONS SYMBOL CLASS VALUE						
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ		НЗВ	> 8 kV		
AEC-Q101-002	Machine model (contact mode)	C = 200 pF, R = 0 Ω		M4	> 400 V		
JESD 22-A114	Human body model (contact mode)	C = 100 pF, R = 1.5 k Ω		3B	> 8 kV		
JESD 22-A115	Machine model (contact mode)	C = 200 pF, R = 0 Ω	V _C	С	> 400 V		
IEC 61000-4-2 ⁽²⁾	Human body model (contact mode)	C = 150 pF, R = 330 Ω		4	> 8 kV		
	Human body model (air-discharge mode) (1)	C = 150 pF, R = 330 Ω		4	> 15 kV		
ISO 10605	Contact mode	$C = 330 \text{ pF}, R = 2 \text{ k}\Omega$		-	20 kV typ.		

Notes

⁽²⁾ System ESD standard

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
MSX1PJ-M3/89A	0.006	89A	4500	7" diameter plastic tape and reel	
MSX1PJHM3/89A (1)	0.006	89A	4500	7" diameter plastic tape and reel	

Note

(1)AEC-Q101 qualified

⁽¹⁾ Immunity to IEC 61000-4-2 air discharge mode has a typical performance > 30 kV

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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

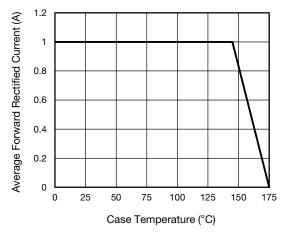


Fig. 1 - Maximum Forward Current Derating Curve

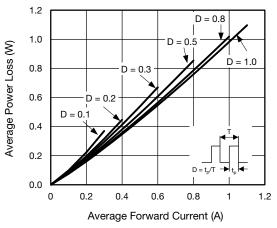


Fig. 2 - Average Power Loss Characteristics

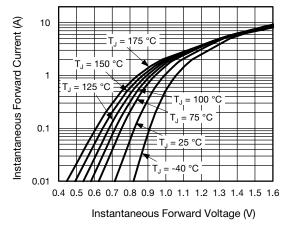


Fig. 3 - Typical Instantaneous Forward Characteristics

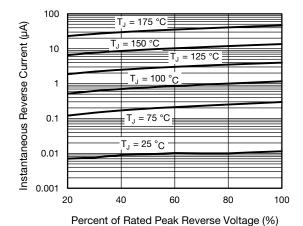


Fig. 4 - Typical Reverse Leakage Characteristics

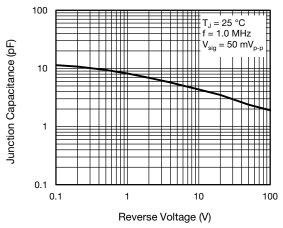


Fig. 5 - Typical Junction Capacitance

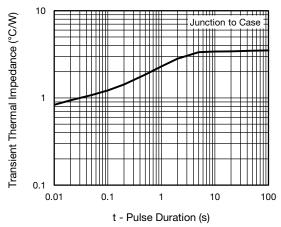


Fig. 6 - Typical Transient Thermal Impedance

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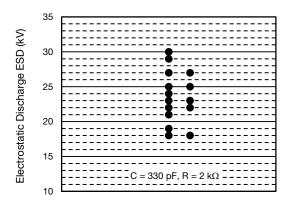
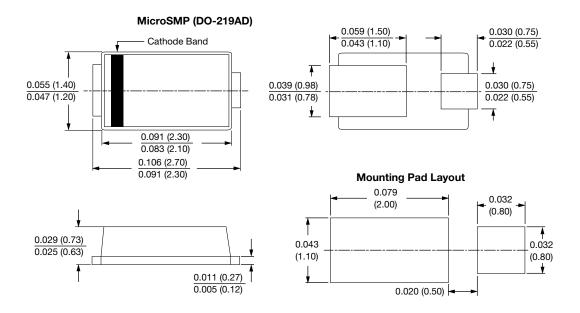


Fig. 7 - ESD Dispersion Map

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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